

PDR3G

3A GLASS PASSIVATED RECTIFIER PowerDI 5

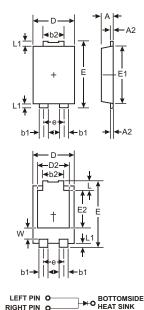
Features

Glass Passivated Die Construction Low Leakage Current High Forward Surge Current Capability Lead Free Finish, RoHS Compliant (Note 1) "Green" Molding Compound (No Br, Sb) Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

Case: PowerDI 5

Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0 Moisture Sensitivity: Level 1 per J-STD-020C Terminals: Finish – Matte Tin annealed over Copper leadframe. Solderable per MIL-STD-202, Method 208 Polarity: See Diagram Marking: See Page 3 Weight: 0.095 grams (approximate)



| PowerDI 5 | | | | |
|----------------------|-----------|------|--|--|
| Dim | Min | Max | | |
| Α | 1.05 | 1.15 | | |
| A2 | 0.33 | 0.43 | | |
| b1 | 0.80 | 0.99 | | |
| b2 | 1.70 1.88 | | | |
| D | 3.90 | 4.05 | | |
| D2 | 3.05 NOM | | | |
| Е | 6.40 | 6.60 | | |
| е | 1.84 NOM | | | |
| E1 | 5.30 5.45 | | | |
| E2 | 3.55 NOM | | | |
| L | 0.75 | 0.95 | | |
| L1 | 0.50 | 0.65 | | |
| W | 1.20 1.50 | | | |
| All Dimensions in mm | | | | |

Note: Pins Left & Right must be electrically connected at the printed circuit board.

Maximum Ratings @ T_A = 25 C unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load. For capacitive load, derate current by 20%.

| Characteristic | Symbol | Value | Unit |
|---|--|-------|------|
| Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage | V _{RRM} V _{RWM} V _R | 400 | V |
| RMS Reverse Voltage | V _{R(RMS)} | 283 | V |
| Average Rectified Output Current (See also figure 4) | lo | 3 | А |
| Non-Repetitive Peak Forward Surge Current 8.3ms Single half sine-wave Superimposed on Rated Load | I _{FSM} | 100 | А |

Thermal Characteristics

| Characteristic | Symbol | Тур | Мах | Unit |
|---|------------------|-------------|-----|------|
| Thermal Resistance Junction to Soldering Point | R JS | | 2.0 | C/W |
| Thermal Resistance Junction to Ambient Air (Note 2) | R _{JA} | 75 | | C/W |
| Thermal Resistance Junction to Ambient Air (Note 3) | R _{JA} | 65 | | C/W |
| Thermal Resistance Junction to Ambient Air (Note 4) | R _{JA} | 45 | | C/W |
| Operating Temperature Range | Tj | -65 to +150 | | °C |
| Storage Temperature Range | T _{STG} | -65 to +150 | | °C |

Notes: 1. RoHS revision 13.2.2003. Glass and High Temperature Solder Exemptions Applied, see EU Directive Annex Notes 5 and 7.

2. FR-4 PCB, 2 oz. Copper, minimum recommended pad layout per http://www.diodes.com/datasheets/ap02001.pdf. TA = 25 C

3. Polymide PCB, 2 oz. Copper, minimum recommended pad layout per http://www.diodes.com/datasheets/ap02001.pdf. TA = 25 C

4. Polymide PCB, 2 oz. Copper. Cathode pad dimensions 9.4mm x 7.2mm. Anode pad dimensions 2.7mm x 1.6mm. TA = 25 C

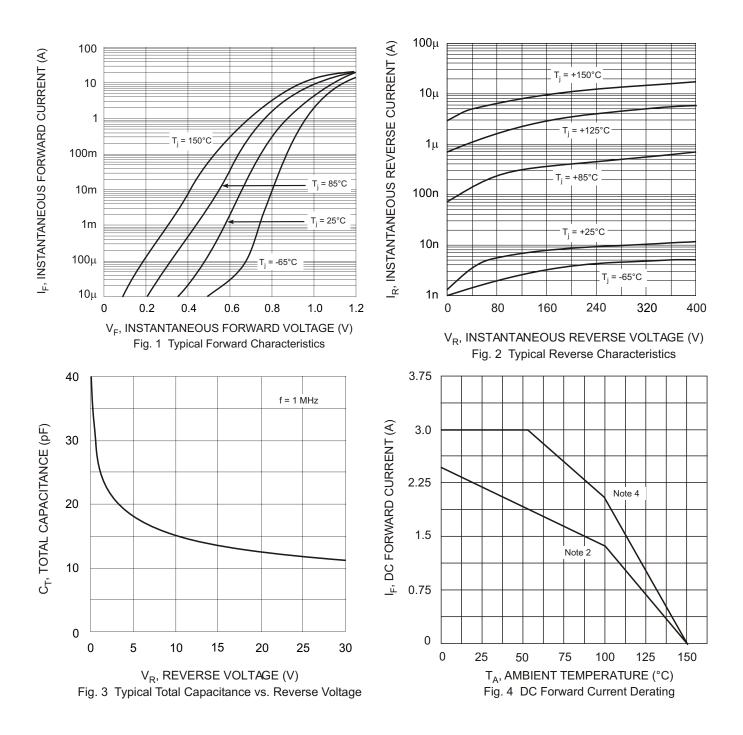
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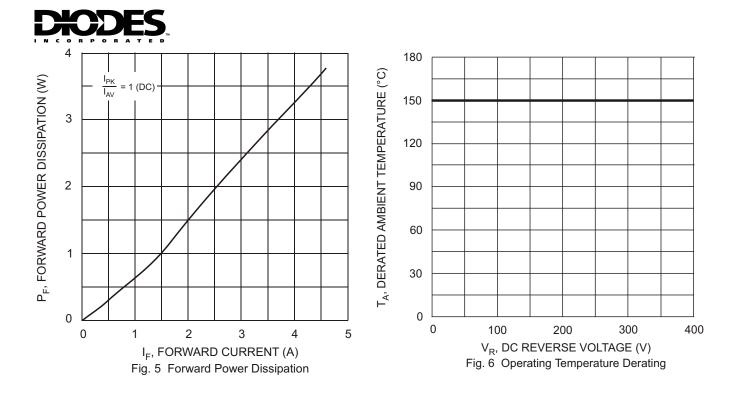


| | | | 1 | | | |
|------------------------------------|--------------------|-----|------------|-----------|------|--|
| Characteristic | Symbol | Min | Тур | Max | Unit | Test Condition |
| Reverse Breakdown Voltage (Note 5) | V _{(BR)R} | 400 | | | V | I _R = 10 A |
| Forward Voltage | VF | | 0.92 | 1.15 | V | I _F = 3A, T _S = 25 C |
| Reverse Leakage Current (Note 5) | IR | | 0.015 6 | 10 250 | A | |
| Reverse Recovery Time | t _{rr} | | 3.0 | | s | $I_F = 0.5A, I_R = 1.0A, I_{rr} = 0.25A$ |

Electrical Characteristics @ T_A = 25 C unless otherwise specified

Notes: 5. Short duration test pulse used to minimize self-heating effect.





| Ordering Information | (Note 6) | | |
|----------------------|----------|-----------|------------------|
| Device | | Packaging | Shipping |
| PDR3G-13 | | PowerDI 5 | 5000/Tape & Reel |

Notes: 6. For Packaging Details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

Marking Information



R3G = Product type marking code || = Manufacturers' code marking YYWW = Date code marking YY = Last two digits of year ex: 05 for 2005 WW = Week code 01 to 52 K = Factory Designator

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